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# Who we are



We employ 125 people



4 locations - a total of 5000 m<sup>2</sup>



wide range of materials and components of well-known world brands



innovative services, modern production lines

Laser plotter CO, Cutting head with oscillating knife







### Member of

- Polish Space Industry Association
- Polish Technological Platform on Photonics
- Polish Chamber of Commerce for Electronics and Telecommunications
- Microelectronics, Electronics & Photonics Cluster













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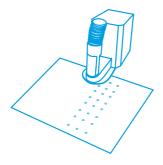
# Our services – converting:



**Cutting** saw

## Log roll Slitting

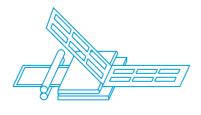
- Maximum length of log roll: 1700 mm
- Minimum tape width: 6 mm
- Cutting accuracy: 0,1 mm
- Maximum diameter of log roll: 430 mm



Laser plotter
– oscillating knife cutter

## **Cutting out**

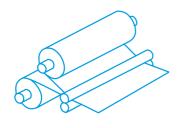
- Working area 1330 mm x 830 mm
- · Cutting demanding materials
- Cutting adhesive transfer tapes
- Cutting foams and other materials
- · Filtering fume extractor



Tact press

### Matrix cutting die: Die-Cut and Kiss-Cut

- Materials with thickness of 0,05 mm to 10 mm
- Working area 300 mm x 300 mm



Laminator

## Laminating

• Operating width up to 1600 mm



# Slitting log rolls and industrial velcros

## We cut using:

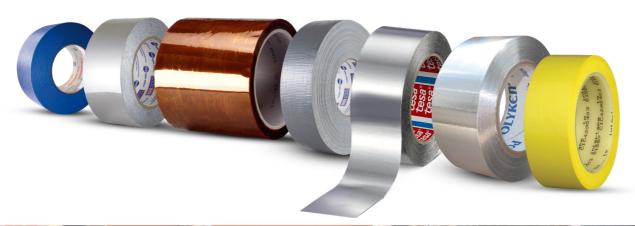
• Specialist machine with a cuvisc

## Technology and materials

The machine enables slitting log rolls (large roll of thin foil, often with a layer of glue) up to 1700 mm long. It is equipped with a PLC controller from Siemens to adjust the speed of the cutting disc. The machine features a built-in disc sharpening and cooling system, a disc wetting system, and a roller pressure system for converting metal foils with no deformation of edges. It ensures high repeatability and smooth cutting line of:

- · Tapes, including types with aggressive, strong glue
- Copper and aluminium foils
- Adhesive transfer tapes
- Velcros









# Cut-outs – laser plotter

## We make cut-outs using:

- A plotter cutter with a CO<sub>2</sub> laser head
- A plotter cutter with a head featuring an oscillating knife cutter

## Technology

- The plotter cutter includes a 1330 x 830 mm working table. Depending on the material cut, we use a CO<sub>2</sub> laser head or head featuring an oscillating knife cutter.
- Using CAD software means that there's not need to prepare dies in advance, which significantly speeds-up the production process.

#### **Materials**

The machine enables precise cutting of demanding materials, such as:

- Foams
- Adhesive transfer tapes
- Thin VHB tapes
- · Poured acrylic
- Plastics
- Cloths
- Foils
- Plywood
- Composites









# I Cut-outs - mechanical die

#### For Die-Cut and Kiss-Cut we use:

• 10t tact press

## Technology and materials

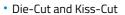
The press enables:

- Die-Cut
  - Cutting-out a shape from the die in the tape with liner cutting
- Kiss-Cut
  - Cutting-out a shape from the die in the tape while leaving the liner intact

The machine can be programmed to cut out a shape with a finger lift, i.e. an additional part that makes it easier to remove the liner from the adhesive side.

The device supports material converting in the following configurations:

• Die-Cut + Kiss-Cut











# Converted materials

### **Tapes**

- · Thermally conductive
- · Polyimide (kapton)
- Electrical (insulating)
- Corrosion Protection
- Self-amalgamating
- Polyester
- Shielding
- VHB, acrylic
- Erosion protection PPT (Polyurethane Protective Tape)
- Aluminium foil
- Copper foil
- Foam
- · Cloth surgical tapes
- Epoxy
- Masking
- Protective foil

# Materials reinforced with glass fibre

#### **Velcros**

#### **Foams**

## Adhesive transfer tapes for lamination

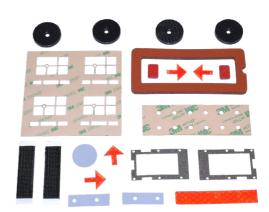
- Acrylic
- Double sided silicone acrylic
- Electrically conductive

### • Silicone









## Our suppliers:

















#### Contact us

#### Headquarters and R&D department

info@semicon.com.pl zamowienia@semicon.com.pl PL 04-761 Warsaw, Zwolenska 43/43a Street +48 22 615 73 71 +48 22 615 64 31

#### Tapes converting

tasmy@semicon.com.pl PL 05-077 Warsaw, Zakretowa 4 Street +48 22 102 22 52

#### **EMS - Electronic Manufacturing Services**

Inquiries: EMSinquiry@semicon.com.pl Orders: EMSorder@semicon.com.pl

General information: EMSinfo@semicon.com.pl

PL 04-805 Warsaw, Ezopa 71a Street +48 22 612 67 92 +48 22 825 24 64

#### Laser modules design and production

lasery@semicon.com.pl PL 04-761 Warsaw, Zwolenska 43/43a Street +48 22 615 73 71

#### SMT Laser cut stencils manufacturing

szablony@semicon.com.pl PL 05-077 Warsaw, Zakretowa 4 Street +48 22 615 27 05 +48 22 102 22 50

#### Main warehouse

(open Mo-Fr, 8:00-16:00 CET) radomszczanska@semicon.com.pl PL 04-764 Warsaw, Radomszczanska 19 Street +48 22 615 83 40 +48 607 180 600







